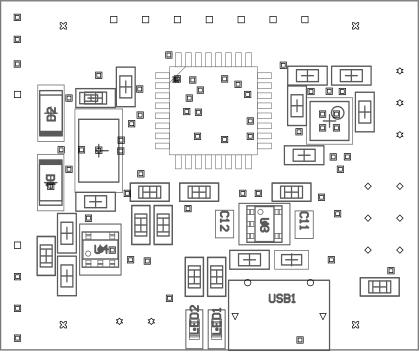
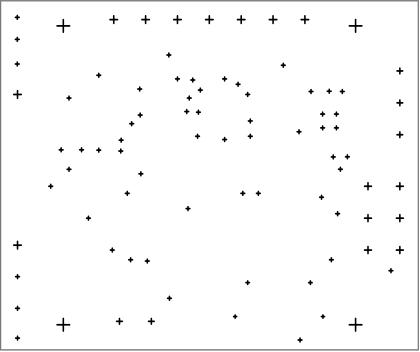
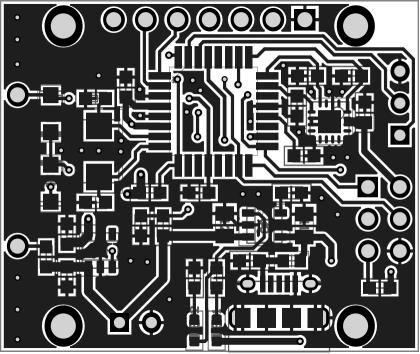
Board Stack Report Layer Stack Stack Up **Board Layer Stack** Name Material Thickness Constant Layer Top Paste Top Overlay 3 Top Solder 3.5 Solder Resist 0.010mm Top Layer 4 0.036mm Copper Dielectric 1 5 FR-4 4.8 1.508mm **Bottom Layer** Copper 6 0.036mm **Bottom Solder** Solder Resist 3.5 0.010mm **Bottom Overlay** 8 **Bottom Paste** 9

Height: 1.600mm

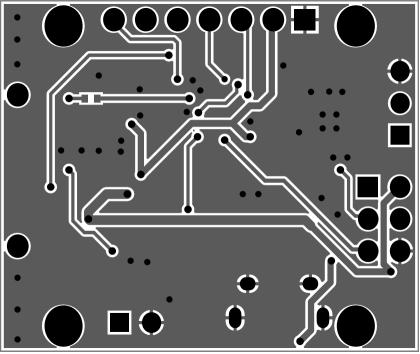


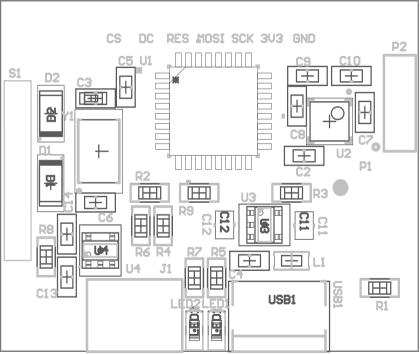












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